
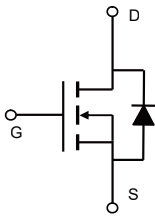


<p><b>Description</b></p> <p>These N-Channel enhancement mode power field effect transistors are using <b>shielded gate trench DMOS</b> technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.</p> <p><b>Features</b></p> <ul style="list-style-type: none"> <li>◆ 40V, 120A, <math>R_{DS(on).max}=2.5m\Omega@V_{GS} = 10V</math></li> <li>◆ Improved dv/dt capability</li> <li>◆ Fast switching</li> <li>◆ 100% EAS Guaranteed</li> <li>◆ Green device available</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>◆ Motor Drives</li> <li>◆ UPS</li> <li>◆ DC-DC Converter</li> </ul>	<p><b>Product Summary</b></p> <table border="0"> <tr> <td><math>V_{DSS}</math></td> <td>40V</td> </tr> <tr> <td><math>R_{DS(on).max}@V_{GS}=10V</math></td> <td>2.5m<math>\Omega</math></td> </tr> <tr> <td><math>I_D</math></td> <td>120A</td> </tr> </table> <p><b>Pin Configuration</b></p> <div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  <p>TO-263</p> </div> <div style="text-align: center;">  <p>Schematic</p> </div> </div>	$V_{DSS}$	40V	$R_{DS(on).max}@V_{GS}=10V$	2.5m $\Omega$	$I_D$	120A
$V_{DSS}$	40V						
$R_{DS(on).max}@V_{GS}=10V$	2.5m $\Omega$						
$I_D$	120A						

**Absolute Maximum Ratings**  $T_C = 25^\circ C$  unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	40	V
Continuous drain current ( $T_C = 25^\circ C$ ) ( $T_C = 100^\circ C$ )	$I_D$	120	A
		99	A
Pulsed drain current <sup>1)</sup>	$I_{DM}$	480	A
Gate-Source voltage	$V_{GSS}$	$\pm 18$	V
Avalanche energy <sup>2)</sup>	$E_{AS}$	306	mJ
Power Dissipation	$P_D$	104	W
Storage Temperature Range	$T_{STG}$	-55 to +150	$^\circ C$
Operating Junction Temperature Range	$T_J$	-55 to +150	$^\circ C$

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.2	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient <sup>3)</sup>	$R_{\theta JA}$	60	$^\circ C/W$

**Package Marking and Ordering Information**

Device	Device Package	Marking	Units/Reel
VST04N025-T3	TO-263	VST04N025-T3	800

**Electrical Characteristics**
 $T_J = 25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static characteristics</b>						
Drain-source breakdown voltage	$BV_{DSS}$	$V_{GS}=0\text{ V}, I_D=250\mu\text{A}$	40	---	---	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0	---	2.1	V
Drain-source leakage current	$I_{DSS}$	$V_{DS}=40\text{ V}, V_{GS}=0\text{ V}, T_J = 25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{DS}=40\text{ V}, V_{GS}=0\text{ V}, T_J = 150^\circ\text{C}$	---	---	10	mA
Gate leakage current, Forward	$I_{GSSF}$	$V_{GS}=18\text{ V}, V_{DS}=0\text{ V}$	---	---	100	nA
Gate leakage current, Reverse	$I_{GSSR}$	$V_{GS}=-18\text{ V}, V_{DS}=0\text{ V}$	---	---	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10\text{ V}, I_D=60\text{ A}, T_J = 25^\circ\text{C}$	---	2	2.5	m $\Omega$
Forward transconductance	$g_{fs}$	$V_{DS} = 20\text{ V}, I_D=30\text{ A}$	---	50	---	S
<b>Dynamic characteristics</b>						
Input capacitance	$C_{iss}$	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V},$ $f = 1\text{ MHz}$	---	3260	---	pF
Output capacitance	$C_{oss}$		---	1224	---	
Reverse transfer capacitance	$C_{rss}$		---	113	---	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 20\text{ V}, V_{GS}=15\text{ V}, I_D = 50\text{ A}$	---	10.8	---	ns
Rise time	$t_r$		---	22.8	---	
Turn-off delay time	$t_{d(off)}$		---	143.8	---	
Fall time	$t_f$		---	72.2	---	
Gate resistance	$R_g$	$V_{GS}=0\text{ V}, V_{DS}=0\text{ V}, f=1\text{ MHz}$	---	2.4	---	$\Omega$
<b>Gate charge characteristics</b>						
Gate to source charge	$Q_{gs}$	$V_{DS}=32\text{ V}, I_D=60\text{ A},$ $V_{GS}= 10\text{ V}$	---	10	---	nC
Gate to drain charge	$Q_{gd}$		---	17.6	---	
Gate charge total	$Q_g$		---	69.7	---	
Gate plateau voltage	$V_{plateau}$		---	3	---	V
Output Charge	$Q_{oss}$	$V_{DS}=32\text{ V}, V_{GS}= 0\text{ V}$	---	58	---	nC
<b>Drain-Source diode characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_S$		---	---	86	A
Pulsed Source Current <sup>(4)</sup>	$I_{SM}$		---	---	344	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0\text{ V}, I_S=40\text{ A}, T_J=25^\circ\text{C}$	---	---	1.2	V
Reverse Recovery Time	$t_{rr}$	$I_S=50\text{ A}, di/dt=100\text{ A}/\mu\text{s},$ $T_J=25^\circ\text{C}$	---	44.4	---	ns
Reverse Recovery Charge	$Q_{rr}$		---	56.8	---	nC

**Notes:**

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2:  $V_{DD}=20\text{ V}, V_{GS}=10\text{ V}, L=0.5\text{ mH}, I_{AS}=35\text{ A}, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
- 3: The value of  $R_{thJA}$  is measured by placing the device in a still air box which is one cubic foot.
4. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

**Electrical Characteristics Diagrams**

Figure 1. Typ. Output Characteristics

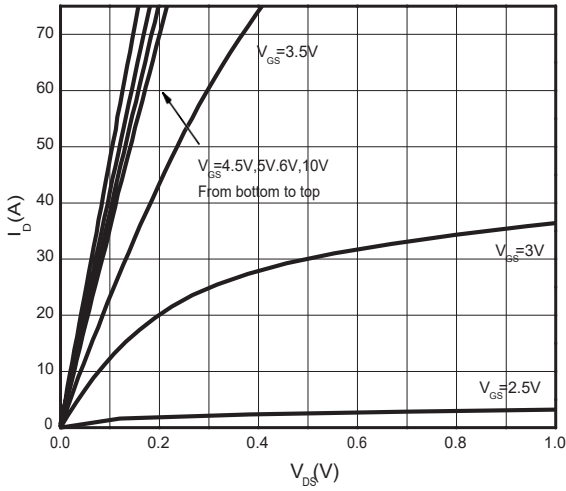


Figure 2. Transfer Characteristics

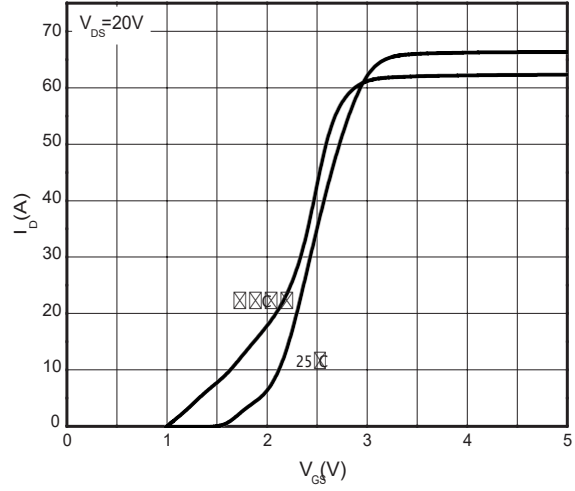


Figure 3. On-Resistance Variation vs. Drain Current

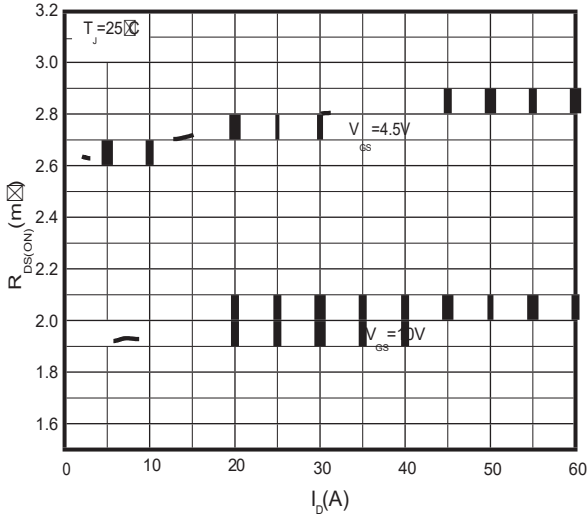


Figure 4. Threshold Voltage vs. Temperature

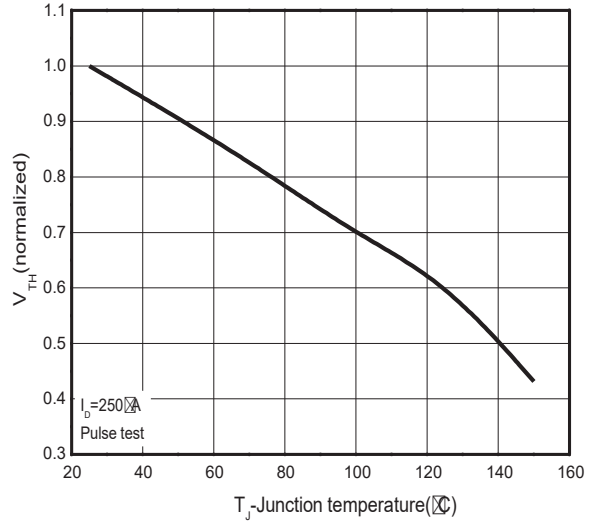


Figure 5. Breakdown Voltage vs. Temperature

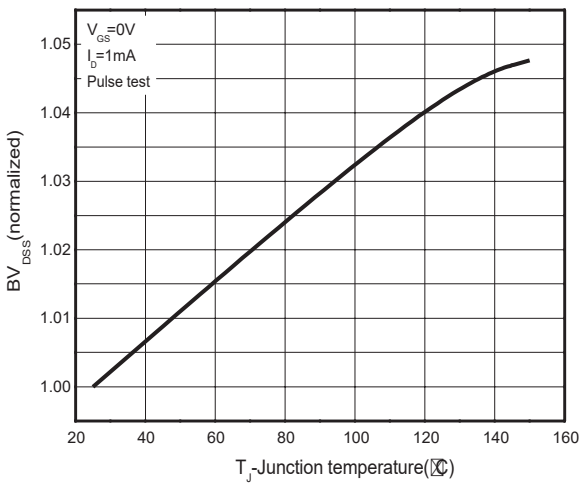
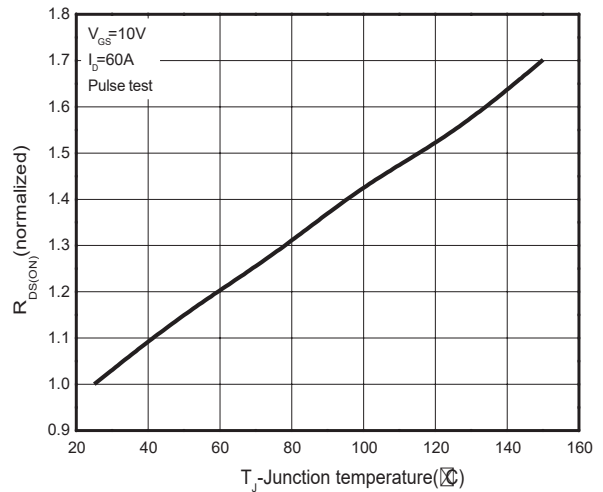


Figure 6. On-Resistance vs. Temperature



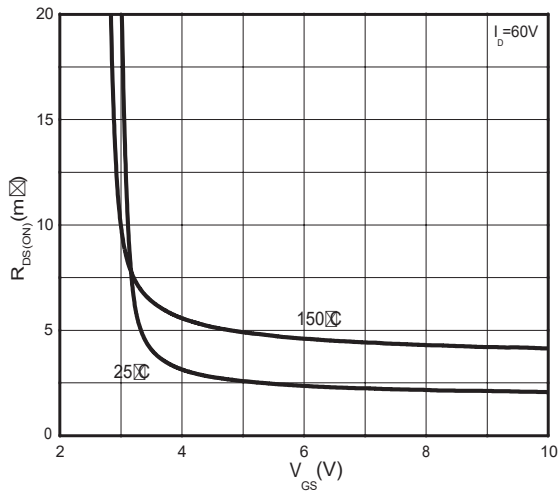
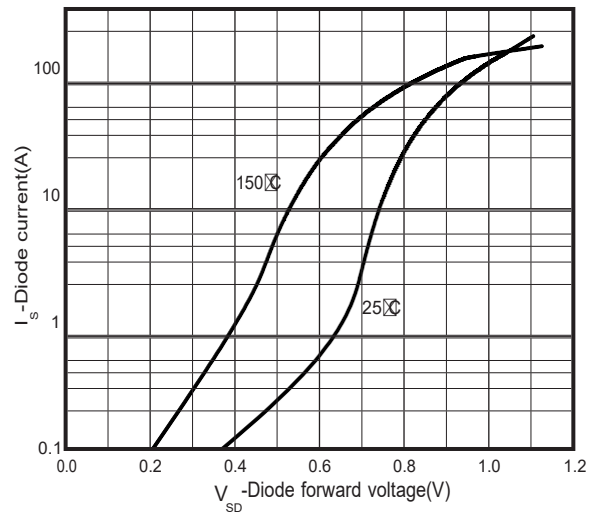
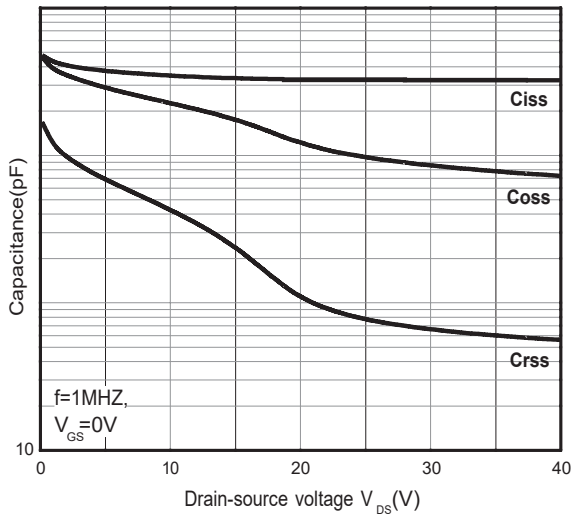
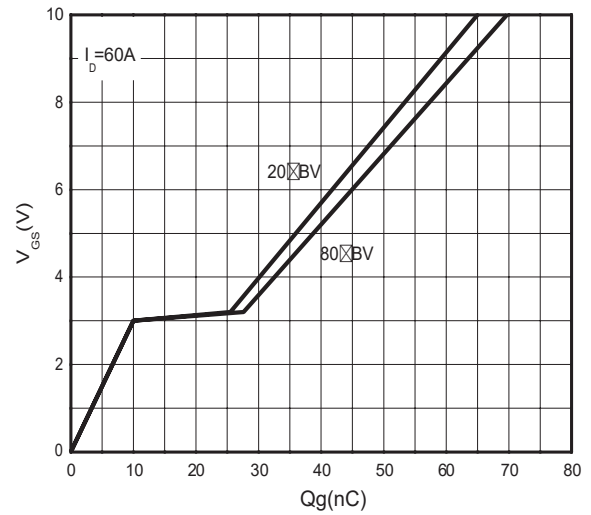
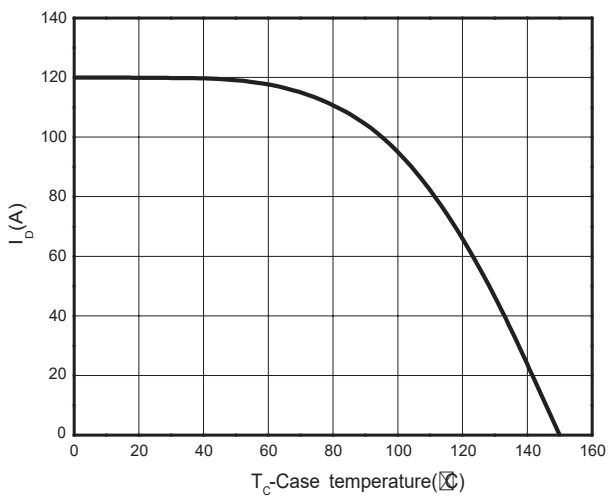
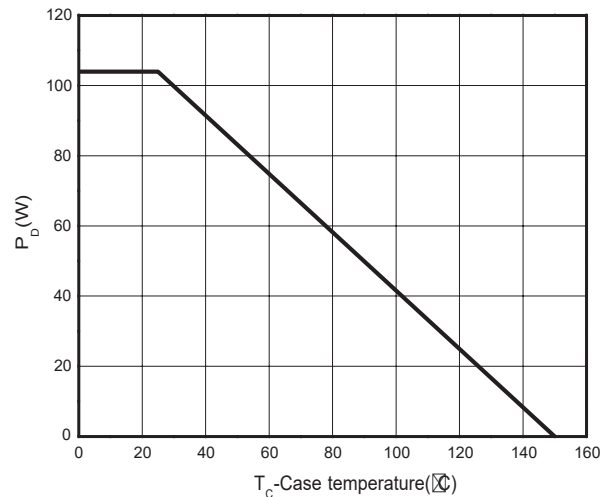
**Figure 7. Rds(on) vs. Gate Voltage**

**Figure 8. Body-Diode Characteristics**

**Figure 9. Capacitance Characteristics**

**Figure 10. Gate Charge Characteristics**

**Figure 11. Drain Current Derating**

**Figure 12. Power Dissipation vs. Temperature**


Figure 13: Safe Operating Area

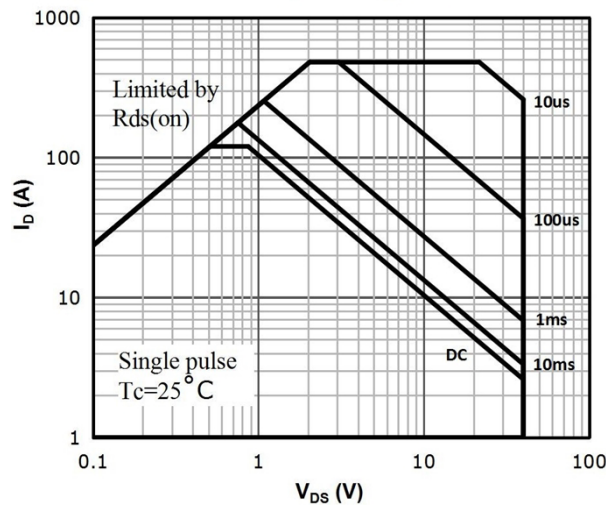
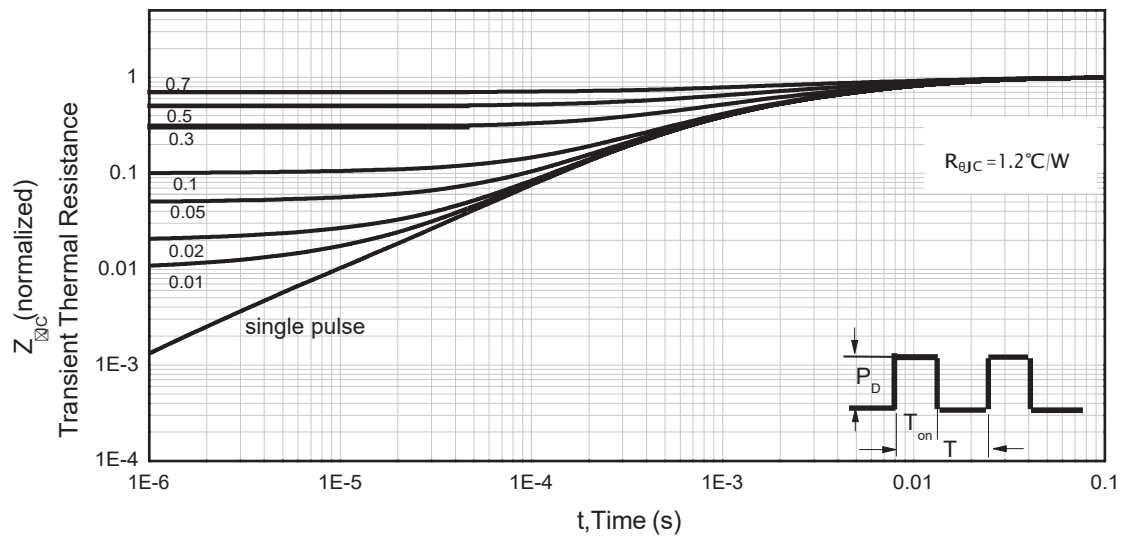
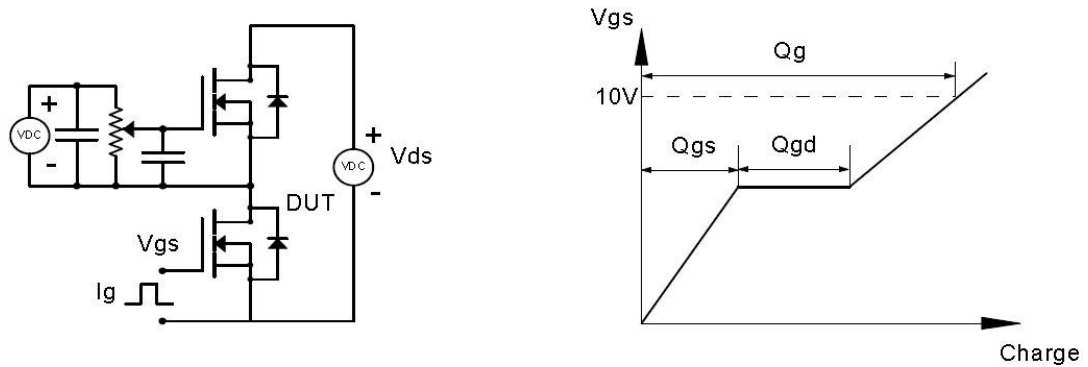
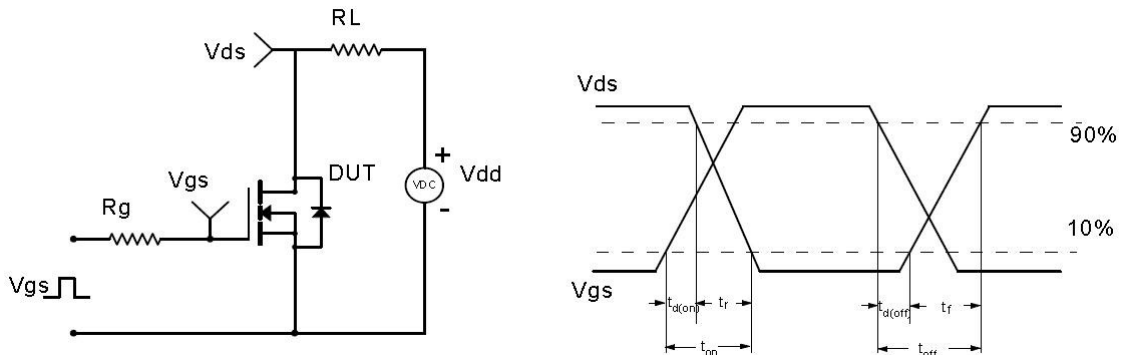
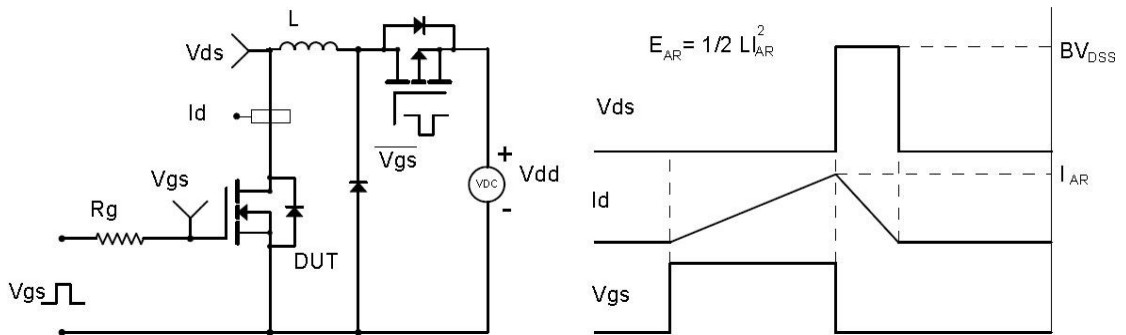


Figure 14. Normalized Maximum Transient Thermal Impedance (RthJC)



**Test Circuit & Waveforms**
**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveforms**

**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**

**Diode Recovery Test Circuit & Waveforms**
